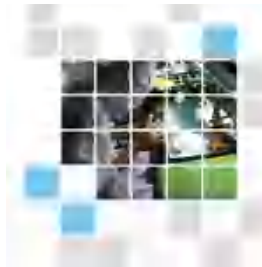


SPECIFICATION

VXT280QSW-01

☐ Preliminary Specification

☐ Final Specification



Approved By:

Date:

RECORD OF REVISION

[illegible]

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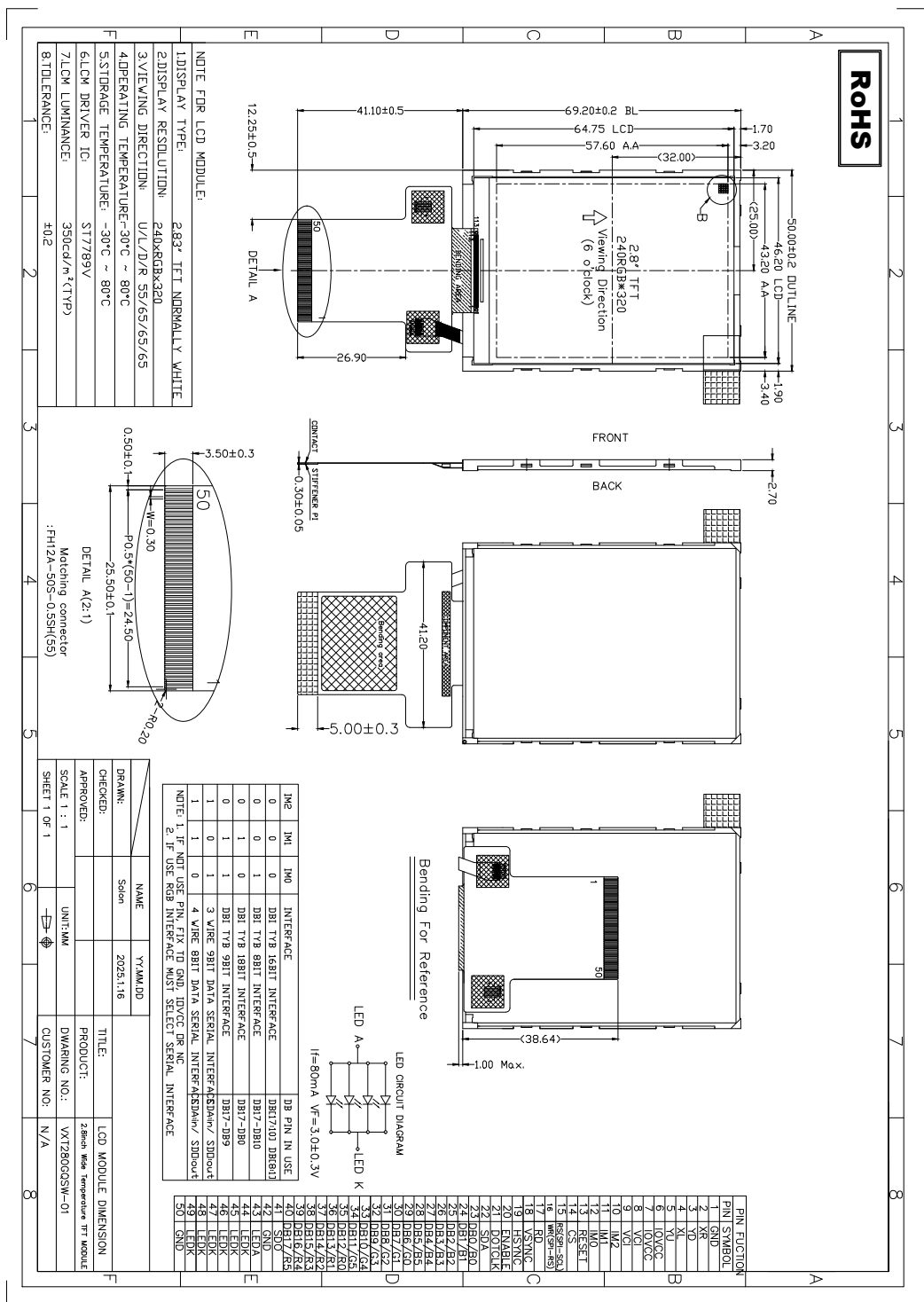
1. Scope

VXT280GQSW-01 is a TFT-LCD module. It is composed of a TFT-LCD panel, driver IC, FPC,a back light unit. The 2.8'' display area contains 240x320 pixels and can display up to 262K colors. This product accords with RoHS environmental criterion.

2. General Specifications

Item	Contents	Unit	Note
LCD Type	TFT	-	
Display color	262K		
Viewing Direction	6	O'Clock	
Gray scale inversion direction	12	O'Clock	
Operating temperature	-30~+80	°C	
Storage temperature	-30~+80	°C	
Module size	2.8	inch	
Active Area(W×H)	43.20x57.60	mm	
Number of Dots	240*320	dots	
Controller	ST7789V	-	
Power Supply Voltage	3.3	V	
Outline Dimensions	50.00x69.20x2.7	mm	
Backlight	4X1-LEDs (white)	pcs	
Weight	---	g	
Interface	RGB/MCU/SPI	-	

3. Outline Drawing



4. Interface Description

Pin No	Symbol	I/O	Function				
1	GND	P	Ground .				
2	XR	I	TP Pin,if not use ,Please NC.				
3	YD	I					
4	XL	I					
5	YU	I					
6-7	IOVCC	P	Power Supply for IO				
8-9	VCI	P	Power Supply for logic.				
10	IM2	I	IM2	IM1	IM0	Interface Mode	DB PIN in use
			0	0	0	80 MCU 16-bit bus	D[17:10], D[8:1]
11	IM1	I	0	0	1	80 MCU 8-bit bus	D[17:10]
			0	1	0	80 MCU 18-bit bus	D[17:0]
12	IM0	I	0	1	1	80 MCU 9-bit bus	D[17:9]
			1	0	1	3-wire 9-bit data serial	SDI: In ,SDO: Out
			1	1	0	4-wire 8-bit data serial	SDI: In ,SDO: Out
13	RESET	I	Reset signal,Signal is active low.				
14	CS	I	Chip select input pin.				
15	RS(SPI-SCL)	I	Display data/command selection pin in parallel interface. This pin is used to be serial interface clock.				
16	WR(SPI-RS)	I	Write enable in MCU parallel interface Display data/command selection pin in serial interface.				
17	RD	I	Read enable in MCU parallel interface.				
18	VSYNC	I	Vertical (Frame) synchronizing input signal for RGB interface operation.				
19	HSYNC	I	Horizontal (Line) synchronizing input signal for RGB interface operation.				
20	ENABLE	I	Data enable signal for RGB interface operation.				
21	DOTCLK	I	Dot clock signal for RGB interface operation.				
22	SDA	I	SPI interface data input /output pin.				
23-40	DB0-DB17	I	Data input.				
41	SDO	O	SPI interface data output pin.				
42	GND	P	Ground.				
43	LEDA	P	LED anode.				
44-49	LEDK	P	LED cathode.				
50	GND	P	Ground.				

5. Absolute Maximum Ratings(Ta=25°C)

5.1 Electrical Absolute Maximum Ratings.(Vss=0V ,Ta=25°C)

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	VCI	-0.3	4.6	V	1, 2
Power Supply Voltage(Logic)	IOVCC	-0.3	4.6	V	

Notes:

1. If the module is above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
2. $V_{DD} > V_{SS}$ must be maintained.

5.2 Environmental Absolute Maximum Ratings.

Item	Storage		Operating		Note
	MIN.	MAX.	MIN.	MAX.	
Ambient Temperature	-30°C	80°C	-30°C	80°C	1,2
Humidity	-	-	-	-	3

1. The response time will become lower when operated at low temperature.
2. Background color changes slightly depending on ambient temperature.
The phenomenon is reversible.
3. $T_a \leq 40^\circ\text{C}$:85%RH MAX.
 $T_a > 40^\circ\text{C}$:Absolute humidity must be lower than the humidity of 85%RH at 40°C .

6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics($V_{ss}=0V$, $T_a=25^{\circ}C$)

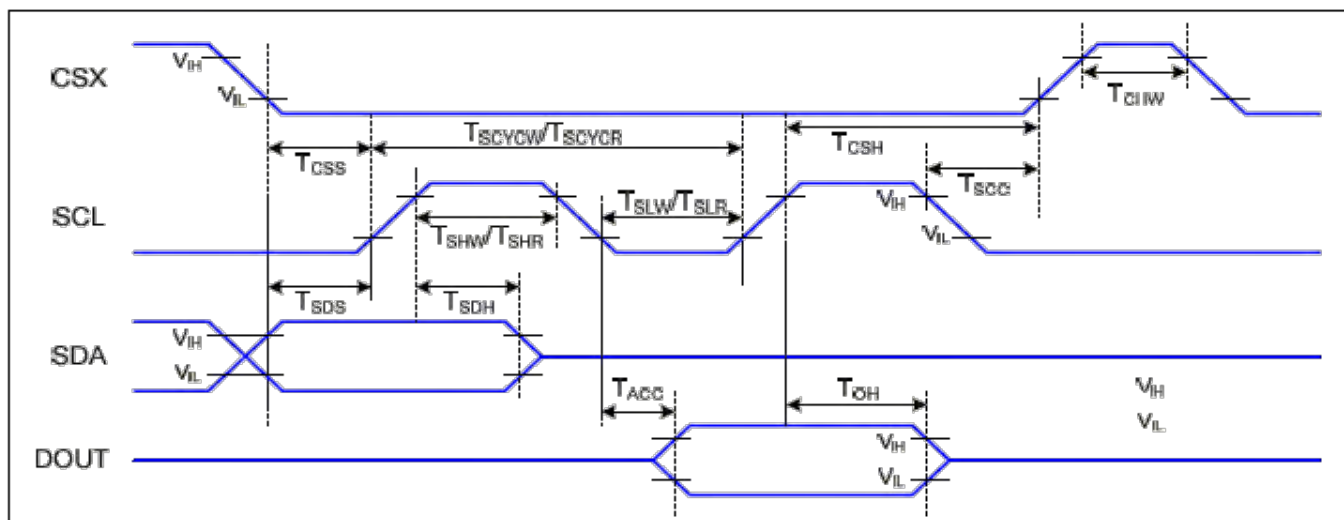
Parameter		Symbol	Condition	Min	Typ	Max	Unit	Note
Power supply		V _{CI}	T _a =25°C	2.4	2.75	3.3	V	
		I _{OVCC}		1.65	1.8	3.3	V	
Input voltage	‘H’	V _{IH}	V _{CC} =3.3V	0.7V _{DDI}	-	V _{DDI}	V	
	‘L’	V _{IL}	V _{CC} =3.3V	0	-	0.3V _{DDI}	V	
Current Consumption		I _{CC}	T _a =25°C	-	TBD	-	mA	
		I _{IOVCC}		-	TBD	-	mA	

Note:

1:When an optimum contrast is obtained in transmissive mode.

2: Tested in 1×1 chessboard pattern.

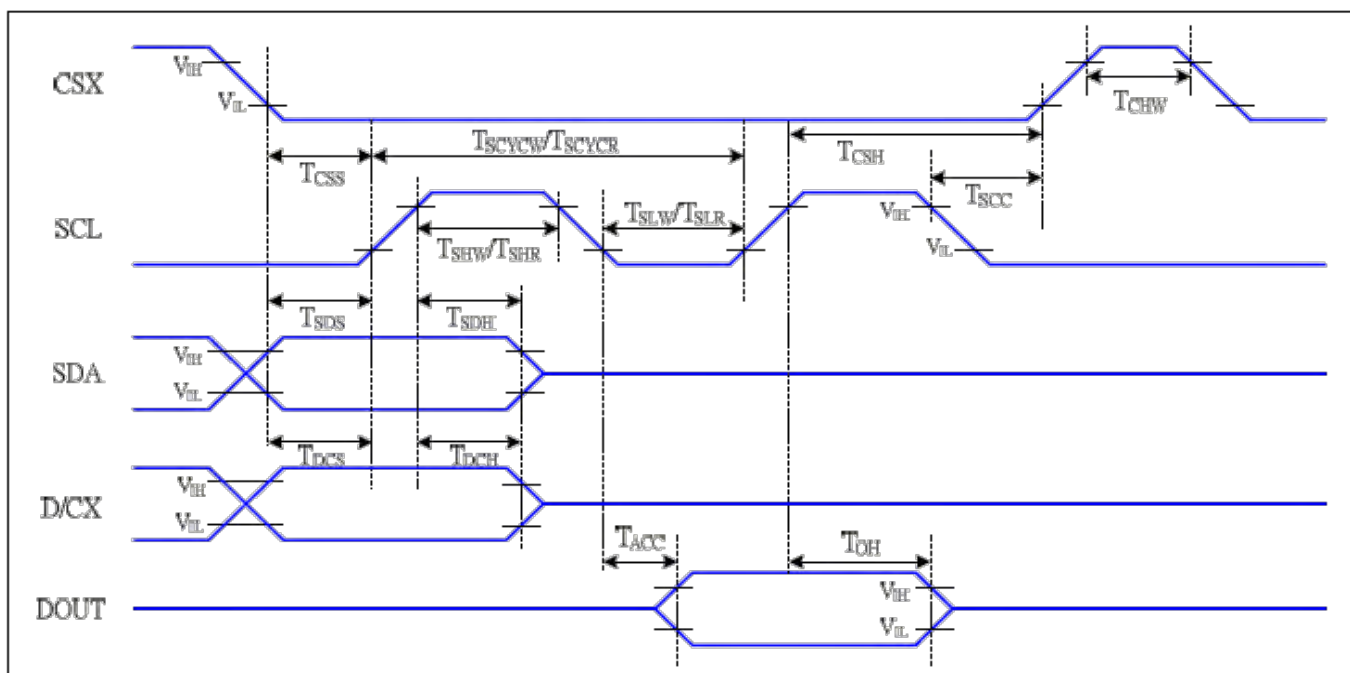
7.2 Serial Interface Characteristics (3-line serial):



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=25°C

Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T _{CSS}	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{SOH}	Chip select hold time (read)	65		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
SCL	T _{SCYCW}	Serial clock cycle (Write)	66		ns	
	T _{SHW}	SCL "H" pulse width (Write)	15		ns	
	T _{SLW}	SCL "L" pulse width (Write)	15		ns	
	T _{SCYCR}	Serial clock cycle (Read)	150		ns	
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA (DIN)	T _{SDS}	Data setup time	10		ns	
	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T _{OH}	Output disable time	15	50	ns	For minimum CL=8pF

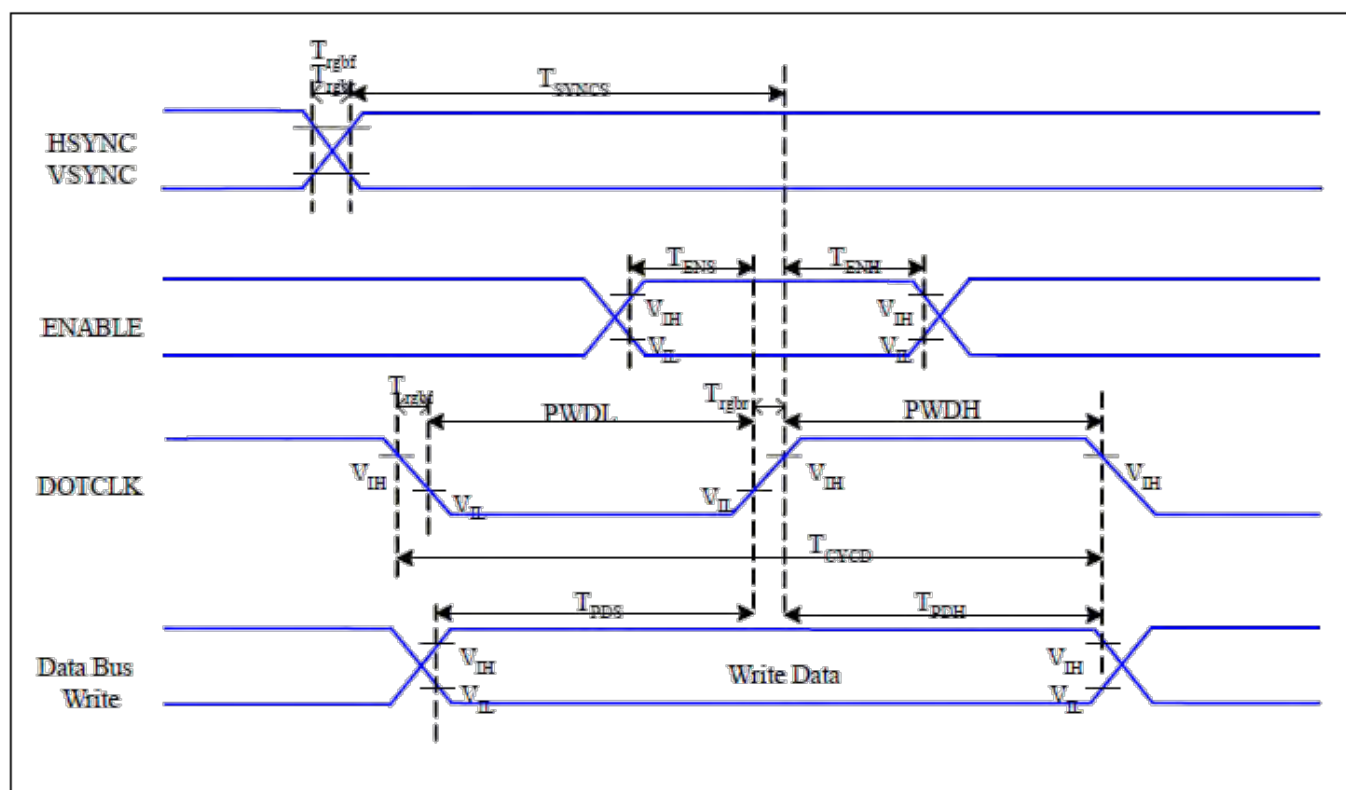
7.3 Serial Interface Characteristics (4-line serial):



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=25°C

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	66		ns	-write command & data ram
	T_{SHW}	SCL "H" pulse width (Write)	15		ns	
	T_{SLW}	SCL "L" pulse width (Write)	15		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	-read command & data ram
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
D/CX	T_{DCS}	D/CX setup time	10		ns	
	T_{DCH}	D/CX hold time	10		ns	
SDA (DIN)	T_{SDS}	Data setup time	10		ns	
	T_{SDH}	Data hold time	10		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

7.4 RGB Interface Characteristics:



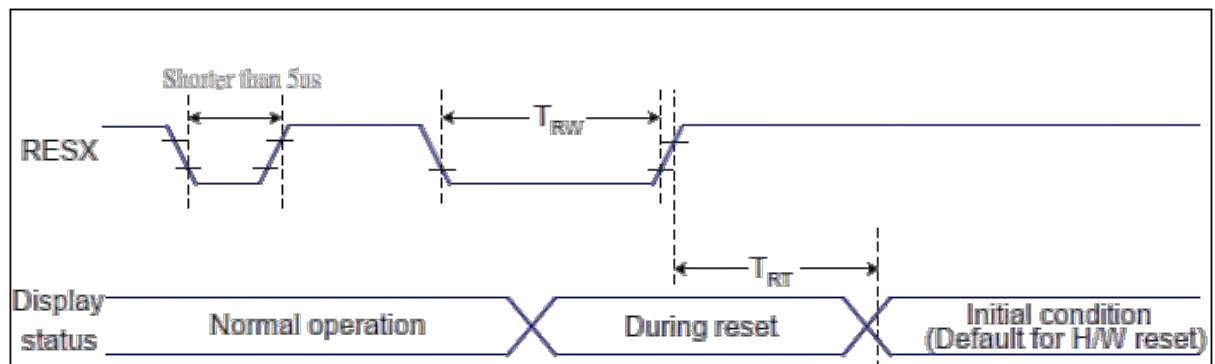
18/16 Bits RGB Interface Timing Characteristics

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	T_{SYNCS}	VSYSNC, HSYNC Setup Time	30	-	ns	
ENABLE	T_{ENS}	Enable Setup Time	25	-	ns	
	T_{ENH}	Enable Hold Time	25	-	ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	60	-	ns	
	PWDL	DOTCLK Low-level Pulse Width	60	-	ns	
	T_{CYCD}	DOTCLK Cycle Time	120	-	ns	
	T_{rghf}, T_{fghf}	DOTCLK Rise/Fall time	-	20	ns	
DB	T_{PDS}	PD Data Setup Time	50	-	ns	
	T_{PDH}	PD Data Hold Time	50	-	ns	

8 6 Bits RGB Interface Timing Characteristics

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	T_{SYNCS}	VSYNC, HSYNC Setup Time	25	-	ns	
ENABLE	T_{ENS}	Enable Setup Time	25	-	ns	
	T_{ENH}	Enable Hold Time	25	-	ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	25	-	ns	
	PWDL	DOTCLK Low-level Pulse Width	25	-	ns	
	T_{CYCD}	DOTCLK Cycle Time	55	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	10	ns	
DB	T_{PDS}	PD Data Setup Time	25	-	ns	
	T_{PDH}	PD Data Hold Time	25	-	ns	

7.5 Reset Timing:



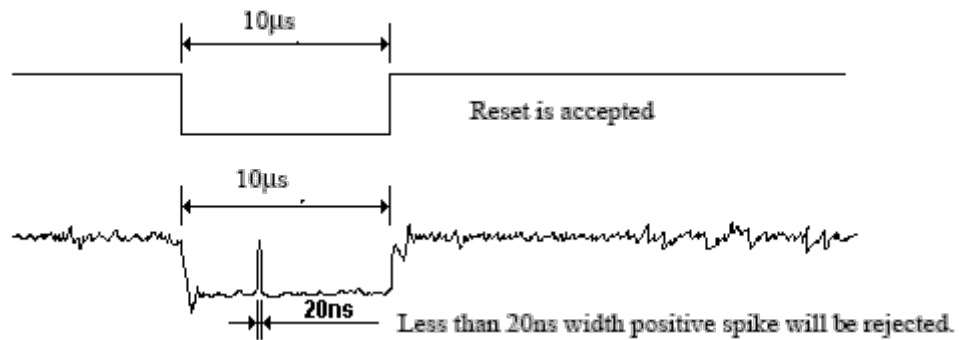
Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5) 120 (Note 1, 6, 7)	ms

Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (t_{RT}) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

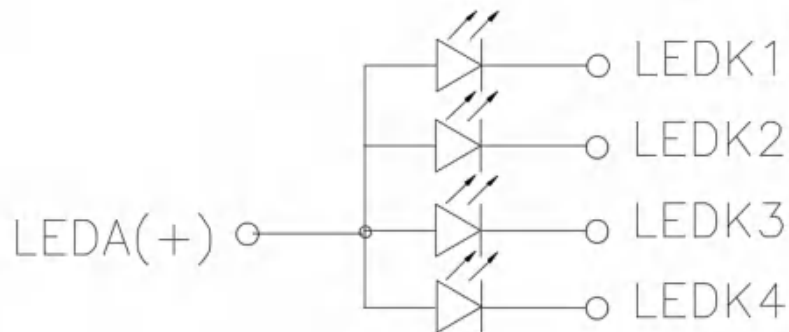
RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

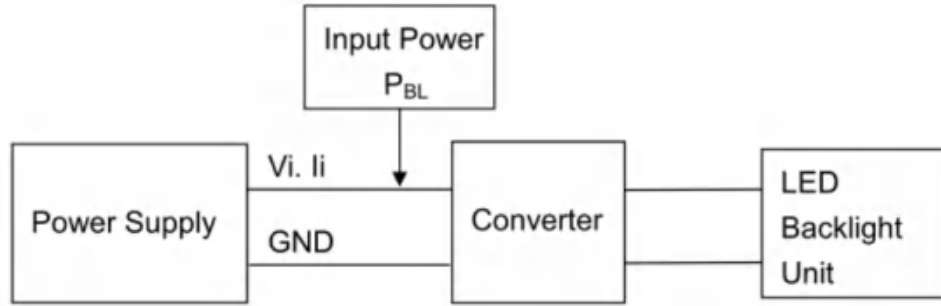
8.Backlight Characteristic



Item	Symbol	Min	Typ	Max	Unit	Test Condition
Supply Voltage	Vf	2.8	3.0	3.3	V	Note 1
Supply Current	If	-	80	-	mA	Note 2
Life Time	-	30000	-	-	Hr	Note 3,4
Backlight Color	White					

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and If =80mA.

Note 2: LED current is measured by utilizing a high frequency current meter as shown below:



Note 3: The “LED life time” is defined as the module brightness decrease to 50% original brightness at $T_a=25^{\circ}\text{C}$ and $I_f=80\text{mA}$. The LED lifetime could be decreased if operating I_f is larger than 80mA.

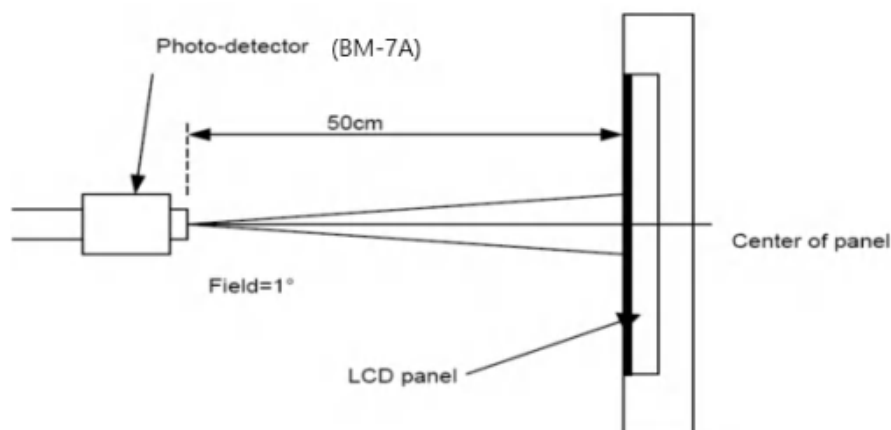
9. Optical Characteristics

Item	Symbol		Condition	Min.	Typ.	Max.	Unit	Note
Brightness	Bp		If=80mA		350	-	Cd/m ²	1
Uniformity	ΔBp		If=80mA	80	-	-	%	1,2
Viewing Angle	3:00		Cr≥10	-	65	-	Deg	1,2
	6:00			-	65	-		
	9:00			-	65	-		
	12:00			-	55	-		
Contrast Ratio	Cr		θ=0° Φ=0°	-	500	-	-	3,4
Response Time	T _r +T _f			-	30	35	ms	4,5
Color of CIE Coordinate	W	x	θ=0° Φ=0°	TYP -0.05	TBD	TYP +0.05	-	1,6
		y			TBD		-	
	R	x			TBD		-	
		y			TBD		-	

	G	x			TBD		-	
		y			TBD		-	
	B	x			TBD		-	
		y			TBD		-	
NTSC Ratio	S			-	50	-	%	

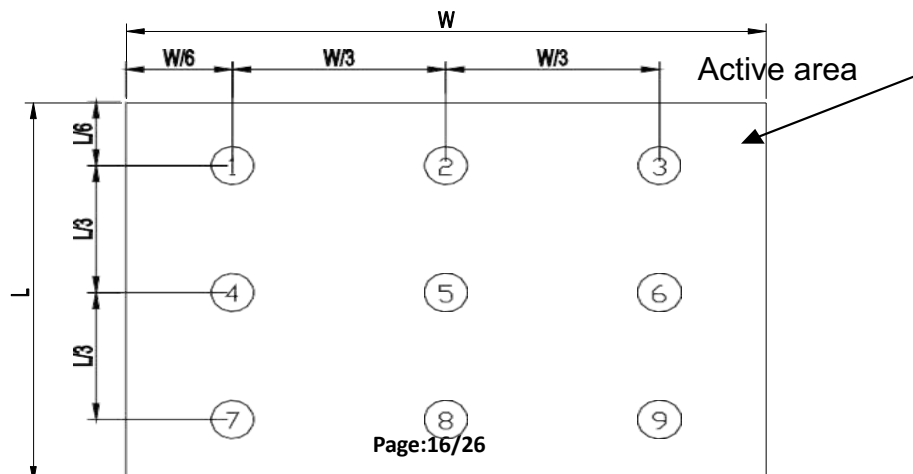
*The parameter is slightly changed by temperature, driving voltage and materiel

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment BM-7A (Φ8mm) Measuring condition:-Measuring surroundings: Dark room.-Measuring temperature: Ta=25℃.-Adjust operating voltage to get optimum contrast at the center of the display. The measured value is more than 5 minutes at the center point of the LCD panel, and the backlight is turned on at the same time.

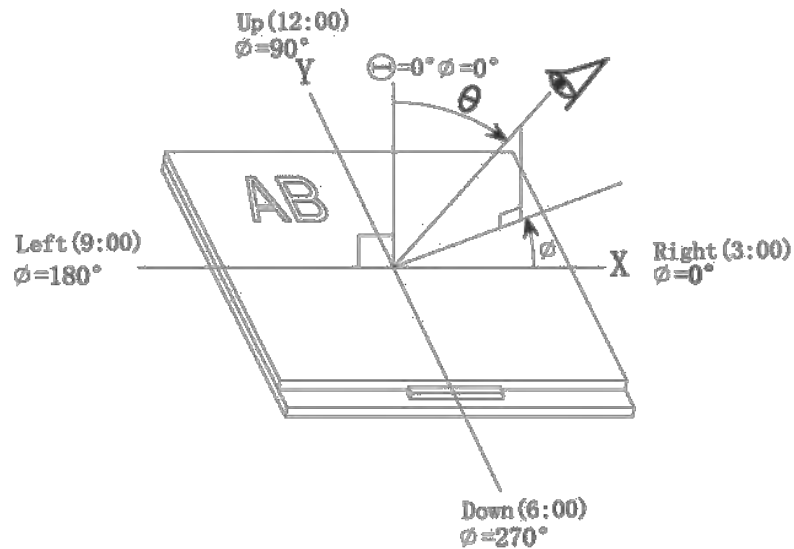


Note 2: The luminance uniformity is calculated by using following formula.

$\Delta Bp = Bp \text{ (Min.)} / Bp \text{ (Max.)} \times 100 \text{ (\%)}; Bp \text{ (Max.)} = \text{Maximum brightness in 9 measured spots}$
 $Bp \text{ (Min.)} = \text{Minimum brightness in 9 measured spots.}$



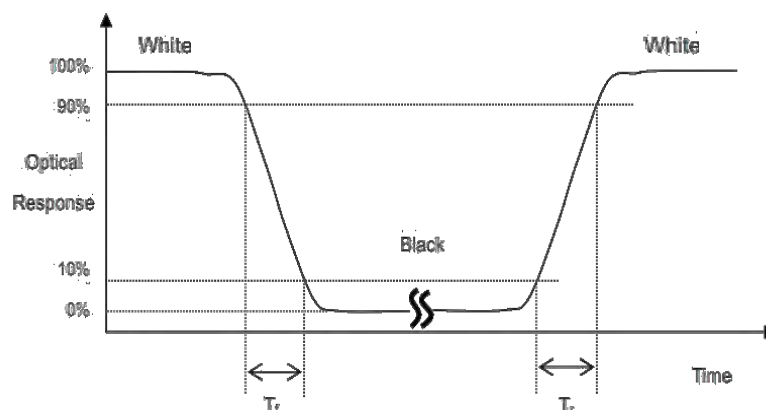
Note 3: The definition of viewing angle: Refer to the graph below marked by θ and ϕ



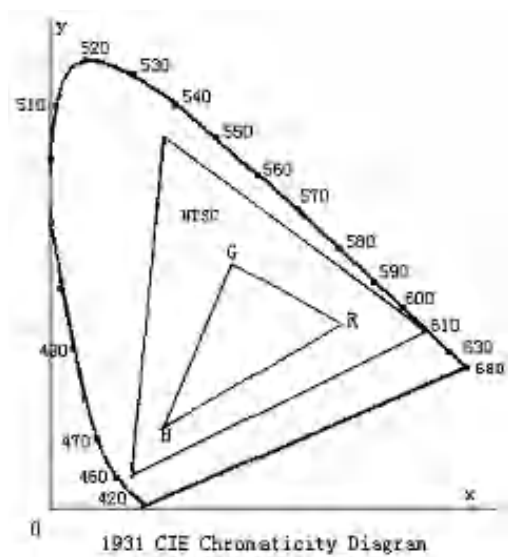
Note 4: Definition of contrast ratio Contrast measurements shall be made at viewing angle of $\Theta = 0$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state.

$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

Note 5: Definition of Response time The output signals of photo detector are measured when the input signals are changed from “white” to “black” (T_f) and from “black” to “white” (T_r), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



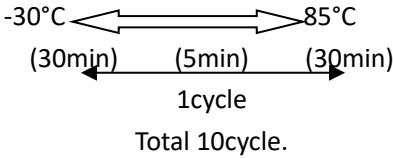
Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.



Color gamut:

$$S = \frac{\text{area of RGB triangle}}{\text{area of NTSC triangle}} \times 100\%$$

10. Reliability Test Conditions and Methods

No.	Test Items	Test Condition	Inspection After Test
①	High Temperature Storage	80°C±2°C×240Hours	Inspection after 2~4hours storage at room temperature, the samples should be free from defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display. 4, Missing segments. 5, Glass crack. 6, Current IDD is twice higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements shall be satisfied. 9. Brightness reduction more than 50%.
②	Low Temperature Storage	-30°C±2°C×240Hours	
③	High Temperature Operating	80°C±2°C×240Hours	
④	Low Temperature Operating	-30°C±2°C×240Hours	
⑤	Temperature Cycle(Storage)		
⑥	Damp Proof Test (Storage)	60°C±5°C×90%RH×240Hours	

REMARK:

- 1, The Test samples should be applied to only one test item.
- 2, Sample side for each test item is 5~10pcs.
- 3, For Damp Proof Test, Pure water(Resistance > 10MΩ) should be used.
- 4, In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

11. Inspection Standard

11.1 Scope

Specifications contain

11.1.1 Display Quality Evaluation

11.1.2 Mechanics Specification

11.2 Sampling Plan

Unless there is other agreement, the sampling plan for incoming inspection shall follow MIL-STD-105E.

11.2.1 Lot size: Quantity per shipment as one lot (different model as different lot).

11.2.2 Sampling type: Normal inspection, single sampling.

11.2.3 Sampling level: Level II.

11.2.4 AQL: Acceptable Quality Level

Major defect: AQL=0.65

Minor defect: AQL=1.5

11.3 Panel Inspection Condition

11.3.1 Environment:

Room Temperature: $25\pm5^{\circ}\text{C}$.

Humidity: $65\pm5\%$ RH.

Illumination: 300 ~ 700 Lux.

11.3.2 Inspection Distance:

35 ± 5 cm

11.3.3 Inspection Angle:

The vision of inspector should be perpendicular to the surface of the Module.

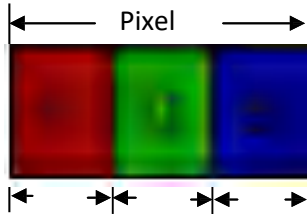
11.3.4 Inspection time:

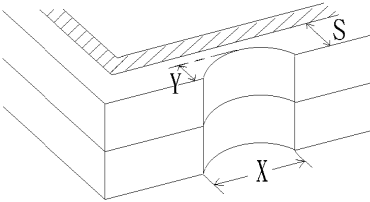
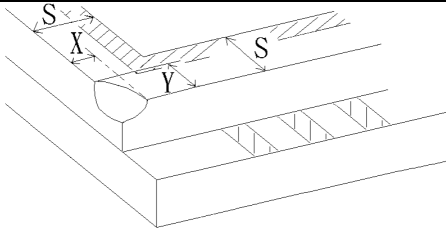
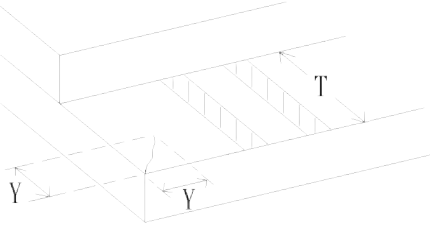
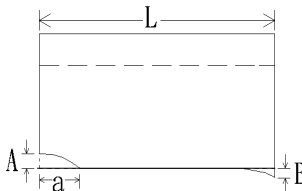
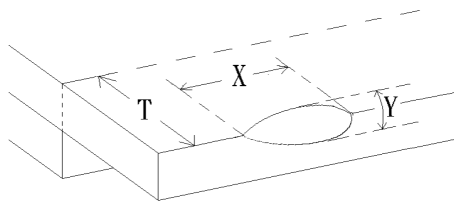
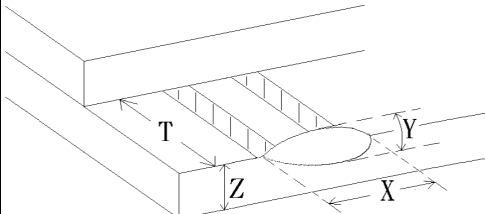
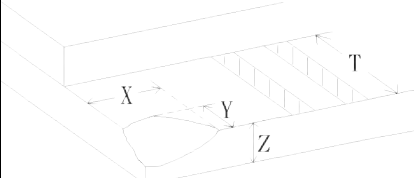
Perceptibility Test Time: 20 seconds max.

11.4 Inspection Plan

Class	Item	Judgment	Class
Packing & Indicate	1. Outside and inside package.	"MODEL NO.", "LOT NO." and "QUANTITY" should indicate on the package.	Minor
	2. Model mixed and quantity.	Other model mixed Quantity short or over	Major
	3. Product indication.	"MODEL NO." should indicate on the product.	Major
Assembly	4. Dimension, LCD glass scratch and scribe defect.	According to specification or drawing.	Major
Appearance	5. Viewing area.	Polarizer edge or LCD's sealing line is visible in the viewing area.....Rejected.	Minor
	6. Blemish, black spot, white spot in the LCD and LCD glass cracks.	According to standard of visual inspection.(inside viewing area)	Minor
	7. Blemish, black spot, white spot and scratch on the polarizer.	According to standard of visual inspection.(inside viewing area)	Minor
	8. Bubble in polarizer.	According to standard of visual inspection.(inside viewing area)	Minor
	9. LCD's rainbow color.	Strong deviation color (or newton ring) of LCD.....Rejected. Or according to limited sample.(if needed, and inside viewing area)	Minor
Electrical	10. Electrical and optical characteristics.(contrast Vop chromaticity....etc)	According to specification or drawing.(inside viewing area)	Major
	11. Missing line.	Missing dot line character	Major
	12.Short circuit. Wrong pattern display.	No display, wrong pattern display, current consumption. Out of specification	Major
	13. Dot defect.(for color and TFT)	According to standard of visual inspection.	Minor

11.5 Standard Of Visual Inspection

NO.	CLASS	ITEM	JUDGMENT																				
11.5.1	Minor	Black and white spot. Foreign materiel. Dust. Blemish. Scratch.	<div>(A) Round type:Unit: mm<table><tr><th>Diameter (mm.)</th><th>Acceptable Q'ty</th></tr><tr><td>$\Phi\leq0.1$</td><td>Disregard</td></tr><tr><td>$0.1 < \Phi\leq0.25$</td><td>2(Distance>10mm)</td></tr><tr><td>$0.25 < \Phi$</td><td>0</td></tr></table>Note: $\Phi = (\text{length}+\text{width})/2$ (B) Linear type:Unit: mm<table><tr><th>Length</th><th>Width (mm.)</th><th>Acceptable Q'ty</th></tr><tr><td>--</td><td>$W\leq0.03$</td><td>Disregard</td></tr><tr><td>$L\leq3.0$</td><td>$0.03 < W\leq0.05$</td><td>1(Distance>10mm)</td></tr><tr><td>--</td><td>$0.05 < W$</td><td>Not allow</td></tr></table></div>	Diameter (mm.)	Acceptable Q'ty	$\Phi\leq0.1$	Disregard	$0.1 < \Phi\leq0.25$	2(Distance>10mm)	$0.25 < \Phi$	0	Length	Width (mm.)	Acceptable Q'ty	--	$W\leq0.03$	Disregard	$L\leq3.0$	$0.03 < W\leq0.05$	1(Distance>10mm)	--	$0.05 < W$	Not allow
Diameter (mm.)	Acceptable Q'ty																						
$\Phi\leq0.1$	Disregard																						
$0.1 < \Phi\leq0.25$	2(Distance>10mm)																						
$0.25 < \Phi$	0																						
Length	Width (mm.)	Acceptable Q'ty																					
--	$W\leq0.03$	Disregard																					
$L\leq3.0$	$0.03 < W\leq0.05$	1(Distance>10mm)																					
--	$0.05 < W$	Not allow																					
11.5.2	Minor	Dent on polarizer.	<div>Unit: mm.<table><tr><th>Diameter</th><th>Acceptable Q'ty</th></tr><tr><td>$\Phi\leq0.1$</td><td>Disregard</td></tr><tr><td>$0.1 < \Phi\leq0.25$</td><td>2(Distance>10mm)</td></tr><tr><td>$0.25 < \Phi$</td><td>0</td></tr></table></div>	Diameter	Acceptable Q'ty	$\Phi\leq0.1$	Disregard	$0.1 < \Phi\leq0.25$	2(Distance>10mm)	$0.25 < \Phi$	0												
Diameter	Acceptable Q'ty																						
$\Phi\leq0.1$	Disregard																						
$0.1 < \Phi\leq0.25$	2(Distance>10mm)																						
$0.25 < \Phi$	0																						
11.5.3	Minor	Bubble in polarizer.	<div>Unit: mm.<table><tr><th>Diameter</th><th>Acceptable Q'ty</th></tr><tr><td>$\Phi\leq0.1$</td><td>Disregard</td></tr><tr><td>$0.1 < \Phi\leq0.25$</td><td>2(Distance>10mm)</td></tr><tr><td>$0.25 < \Phi$</td><td>0</td></tr></table></div>	Diameter	Acceptable Q'ty	$\Phi\leq0.1$	Disregard	$0.1 < \Phi\leq0.25$	2(Distance>10mm)	$0.25 < \Phi$	0												
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11.5.4	Minor	Dot defect	<div><table><tr><th>Items</th><th>Acceptable Q'ty</th></tr><tr><td>Bright dot</td><td>$N\leq3$</td></tr><tr><td>Dark dot</td><td>$N\leq3$</td></tr><tr><td>Total dot</td><td>$N\leq6$</td></tr></table><div>Pixel define :<div><div>Pixel</div></div><div>DotDotDot</div><div>Note1: The definition of dot: The size of a defective dot over 1/2 of whole dot is regarded as one defective dot. Note 2: Bright dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern. Note 3: The bright dot defect must be visible through 2% ND filter Note 4: Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue</div></div></div>	Items	Acceptable Q'ty	Bright dot	$N\leq3$	Dark dot	$N\leq3$	Total dot	$N\leq6$												
Items	Acceptable Q'ty																						
Bright dot	$N\leq3$																						
Dark dot	$N\leq3$																						
Total dot	$N\leq6$																						

11.5.5	Minor	LCD glass chipping.	 <p>$Y > S$ Reject</p>
11.5.6	Minor	LCD glass chipping.	 <p>X or $Y > S$ Reject</p>
11.5.7	Major	LCD glass crack.	 <p>$Y > (1/2) T$ Reject</p>
11.5.8	Major	LCD glass scribe defect.	 <p>1. $a > L/3$, $A > 1.5\text{mm}$ Reject 2. B : According to dimension</p>
11.5.9	Minor	LCD glass chipping. (on the terminal area)	 <p>$\Phi = (x+y)/2 > 2.5\text{mm}$ Reject</p>
11.5.10	Minor	LCD glass chipping. (on the terminal surface)	 <p>$Y > (1/3)T$ Reject</p>
11.5.11	Minor	LCD glass chipping.	 <p>$Y > T$ Reject</p>

12. Handling Precautions

12.1 Mounting method

The TFT module consists of two thin glass plates with polarizers which easily be damaged. And since the module is so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly.

- Isopropyl alcohol.

- Ethyl alcohol.

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water.

- Aromatics.

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux.

- Chlorine (Cl) , Sulfur (S).

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happens by miss-handling or using some materials such as Chlorine (Cl), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module uses C-MOS LSI drivers, so we recommend that you:

Connect any unused input terminal to POWER or GROUND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit causes the shorter LCD life.
- An electro chemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by anything else.

[It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

12.7 Safety

- It is recommendable to crush damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to TFT , and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

- END